

WNSC201200W

Silicon Carbide Diode Rev.03 - 12 November 2020

Product data sheet

1. General description

Silicon Carbide Schottky diode in a TO247-2L plastic package, designed for high frequency switched-mode power supplies.



2. Features and benefits

- Highly stable switching performance
- High forward surge capability I_{FSM}
- Extremely fast reverse recovery time
- Superior in efficiency to Silicon Diode alternatives
- Reduced losses in associated MOSFET
- Reduced EMI
- Reduced cooling requirements
- RoHS compliant
- High junction operating temperature capability (T_{j(max)} = 175 °C)

3. Applications

- Power factor correction
- Telecom / Server SMPS
- UPS
- PV inverter
- PC Silverbox
- LED / OLED TV
- Motor Drives

4. Quick reference data

Table 1. Q	uick reference data					
Symbol	Parameter	Conditions	Values			Unit
Absolute	maximum rating					
V_{RRM}	repetitive peak reverse voltage		1200			V
$I_{F(AV)}$	average forward current	δ = 0.5 ; square-wave pulse; T _{mb} ≤ 131 °C; Fig. 1; Fig. 2; Fig. 3; Fig. 4	20		A	
T _j	junction temperature		175		°C	
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static ch	aracteristics					
V _F	forward voltage	I _F = 20 A; T _j = 25 °C; <u>Fig. 6</u>	-	1.4	1.6	V
		I _F = 20 A; T _j = 150 °C; <u>Fig. 6</u>	-	1.85	2.3	V
		I _F = 20 A; T _j = 175 °C; <u>Fig. 6</u>	-	2	2.6	V
Dynamic	characteristics					
Q _r	recovered charge	$I_F = 20 \text{ A}; V_R = 400 \text{ V}; dI_F/dt = 500 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 8$	-	52	-	nC

5. Pinning information

Table 2.	Pinning infor	mation		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	К	cathode		к-К-А
2	А	anode		001aaa020
mb	К	mounting base; connected to cathode	С С 	

6. Ordering information

Table 3. Ordering information								
Type number	Package	Orderable part number	Packing	Small packing	Package	Package		
	name		method	quantity	version	issue date		
WNSC201200W	TO247-2L	WNSC201200WQ	Tube	30	TO247L-2L	10-Nov-2020		

7. Marking

Table 4. Marking codes					
Type number	Marking codes				
WNSC201200W	WNSC201200W				

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V _{RRM}	repetitive peak reverse voltage		1200	V
V _{RWM}	crest working reverse voltage		1200	V
V _R	reverse voltage	DC	1200	V
I _{F(AV)}	average forward current	δ = 0.5 ; square-wave pulse; T _{mb} ≤ 131 °C; Fig. 1; Fig. 2; Fig. 3; Fig. 4	20	A
I _{FRM}	repetitive peak forward current	δ = 0.5 ; t _p = 25 μs; T _{mb} ≤ 131 °C; square-wave pulse	40	A
I _{FSM}	non-repetitive peak	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	220	A
	forward current	$t_p = 10 \ \mu s; T_{j(init)} = 25 \ ^{\circ}C; sine-wave pulse$	1440	A
l ² t	I ² t for fusing	sine-wave pulse; $T_{j(init)} = 25 \text{ °C}$; $t_p = 10 \text{ ms}$	242	A ² s
T _{stg}	storage temperature		-55 to 175	°C
T _j	junction temperature		175	°C

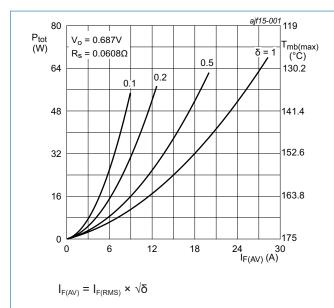


Fig. 1. Forward power dissipation as a function of average forward current; square waveform; typical values

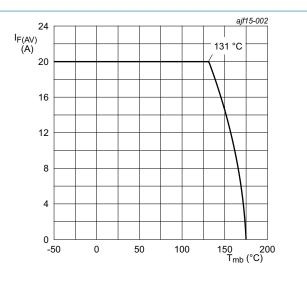
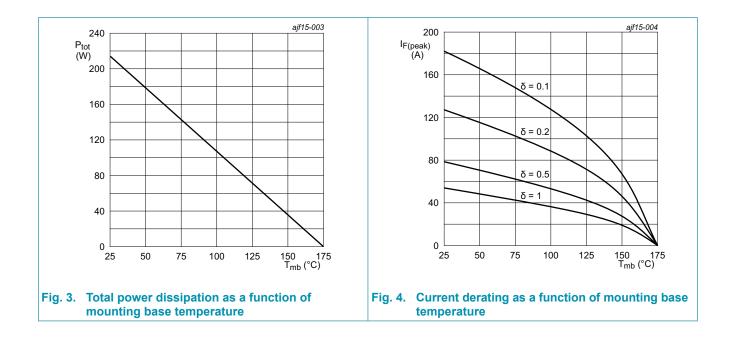


Fig. 2. Forward current as a function of mounting base temperature; typical values

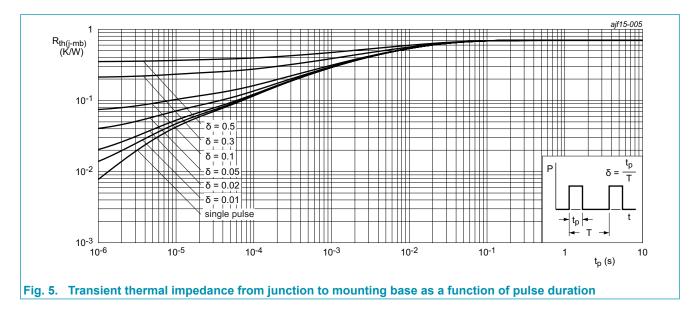
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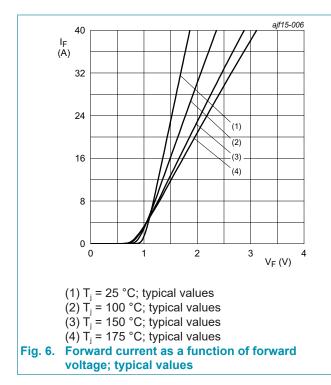
9. Thermal characteristics

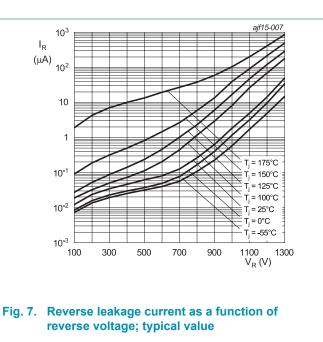
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{\text{th(j-mb)}}$	thermal resistance from junction to mounting base	<u>Fig. 5</u>	-	-	0.7	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	in free air	-	40	-	K/W



10. Characteristics

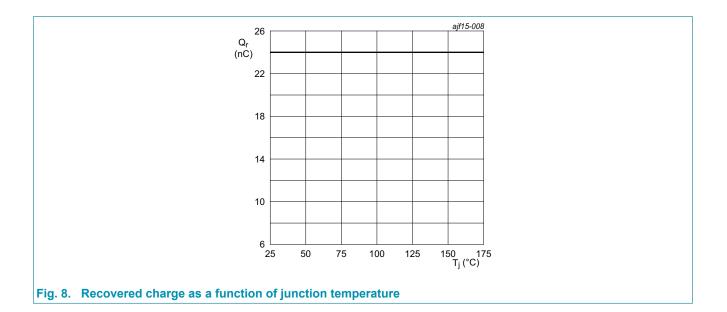
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	aracteristics	· · · · · · · · · · · · · · · · · · ·				
V _F	forward current	I _F = 20 A; T _j = 25 °C; <u>Fig. 6</u>	-	1.4	1.6	V
		I _F = 20 A; T _j = 150 °C; <u>Fig. 6</u>	-	1.85	2.3	V
		I _F = 20 A; T _j = 175 °C; <u>Fig. 6</u>	-	2	2.6	V
I _R	reverse current	V _R = 1200 V; T _j = 25 °C; <u>Fig. 7</u>	-	20	220	μA
		V _R = 1200 V; T _j = 175 °C; <u>Fig. 7</u>	-	900	-	μA
Dynamic	characteristics	· · · ·		_		
Q _r	recovered charge	$I_F = 20 \text{ A}; V_R = 400 \text{ V}; \text{ d}I_F/\text{d}t = 500 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; \text{ Fig. 8}$	-	52	-	nC
C _d	diode capacitance	f = 1 MHz; V _R = 1 V; T _j = 25 °C	-	1020	-	pF
		f = 1 MHz; V _R = 400 V; T _j = 25 °C	-	96	-	pF
		f = 1 MHz; V _R = 800 V; T _j = 25 °C	-	82	-	pF



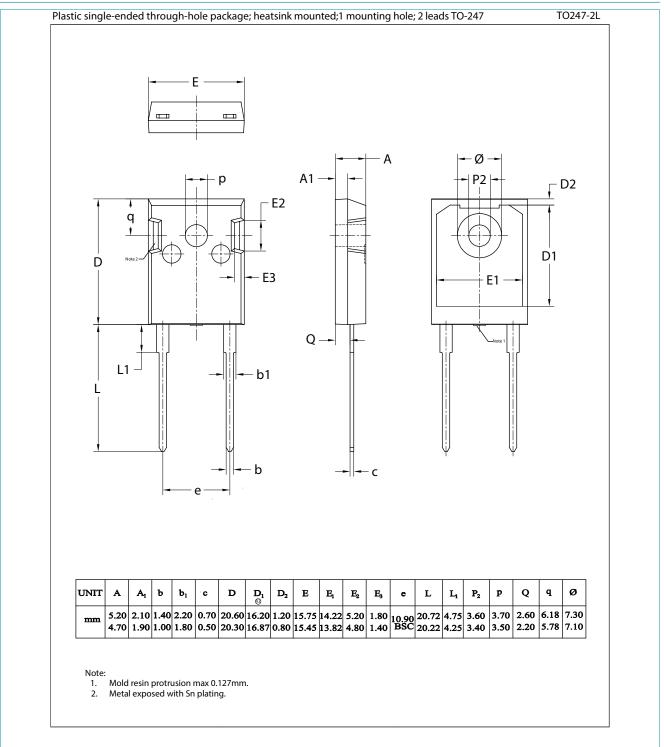


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Silicon Carbide Diode



11. Package outline



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12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

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